

AMD's new GPU lineup aims to rival Nvidia in data centre AI market

 capacitymedia.com/article/amd-new-data-centre-gpus

Ben Wodecki

October 10, 2024



AMD has come out swinging in the GPU battle to take on Nvidia unveiling new hardware and plans to launch new units yearly to keep pace with its rival's annual product cycle.

At the company's Advancing AI event in San Francisco, AMD provided greater clarity on its data centre hardware, including the MI325X and MI350X, unveiled earlier this year.

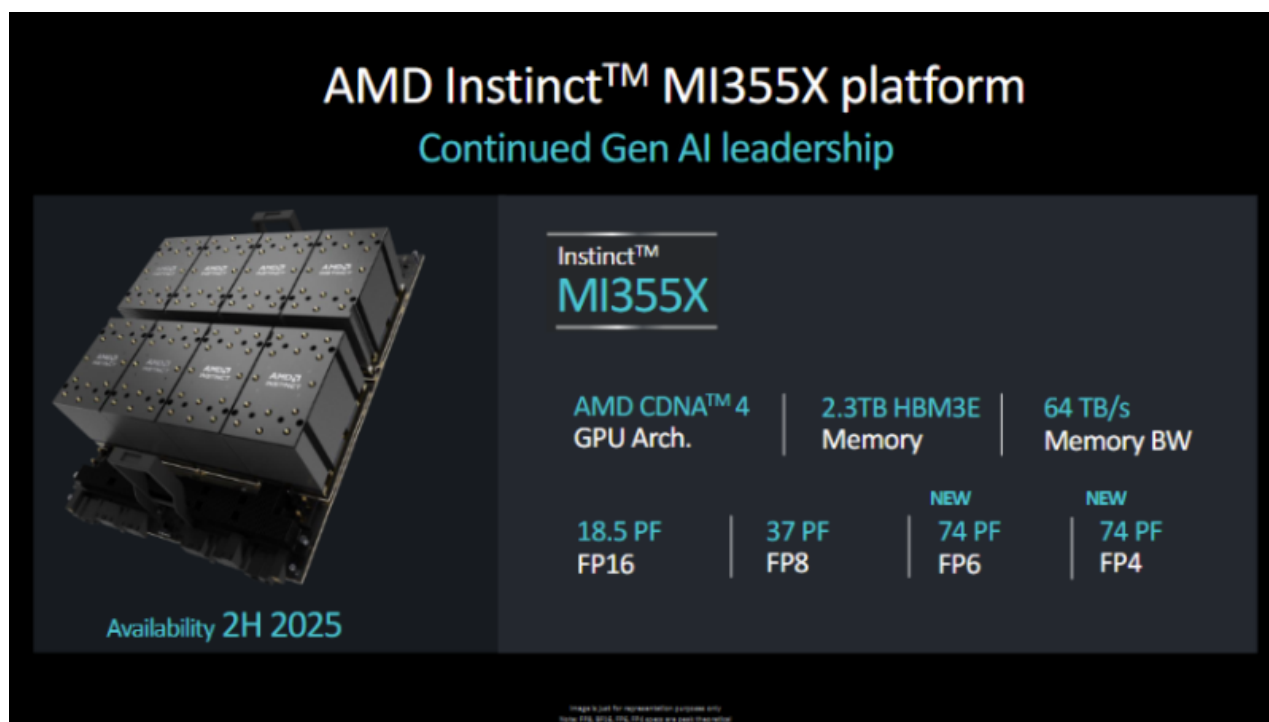
AMD also revealed the MI355X and teased a complete architectural overhaul coming to its GPUs in 2026.

The headline GPU update was the reveal of the MI355X — the next in AMD's MI350 series and a potential challenger to Nvidia's Blackwell GPUs.

Andrew Dieckmann, corporate VP and general manager for data centre GPUs at AMD, told a press gathering that the MI355X represents a “complete bottoms-up redesign” of AMD's Instinct hardware.

The MI355X marks a move to a 3nm process with the chips housing a total of 10 compute elements and eight integrated memory stacks, enabling it to support up to 288GB of HBM3E.

AMD has also added support for new data types, including FP4 (4-bit floating point) and FP6 (6-bit floating point). These are lower-precision data types that can boost running AI and machine learning applications by increasing computational throughput, enhancing energy efficiency, and minimising data movement overhead, making them ideal for large-scale and power-constrained environments.

A presentation slide for the AMD Instinct™ MI355X platform. The slide features a dark background with a 3D rendering of the GPU on the left. The title 'AMD Instinct™ MI355X platform' is at the top in white, with the subtitle 'Continued Gen AI leadership' in teal below it. The main content area is divided into two columns. The left column lists 'Instinct™ MI355X', 'AMD CDNA™ 4 GPU Arch.', and '18.5 PF FP16'. The right column lists '2.3TB HBM3E Memory', '64 TB/s Memory BW', and two new features: 'NEW 74 PF FP6' and 'NEW 74 PF FP4'. At the bottom left, it says 'Availability 2H 2025'. A small disclaimer at the bottom center reads 'Images are for representation purposes only. Specifications are subject to change without notice.'

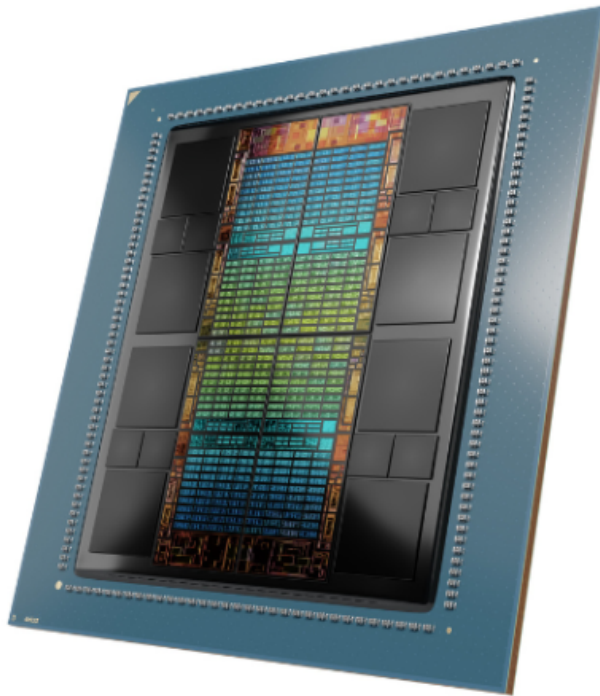
AMD Instinct™ MI355X platform			
Continued Gen AI leadership			
Instinct™ MI355X			
AMD CDNA™ 4 GPU Arch.	2.3TB HBM3E Memory	64 TB/s Memory BW	
18.5 PF FP16	37 PF FP8	NEW 74 PF FP6	NEW 74 PF FP4
Availability 2H 2025			

The MI355X provides substantial increases in the total compute capabilities of AMD’s data centre GPUs, notably a 50% increase over the current-gen MI300X, supporting eight terabytes per second per GPU and 288 gigabytes of total memory capacity.

“When we look at the comparison of what the extra compute means, as well as the memory bandwidth, the support of the lower precision data formats, along with the increased memory footprint, allows us to support up to six times the parameters into a single GPU platform. We’re pretty excited about those capabilities and bringing that to the market,” Dieckmann said.

It’ll be some time though before the MI355X finds its way into data centres, with the hardware expected to start shipping in the second half of 2025.

MI325X updates



While infrastructure providers will have to wait for MI355X, they can get their hands on another AMD GPU a bit sooner: The MI325X, which AMD confirmed will start shipping towards the end of 2024.

Brad McCredie, corporate VP at AMD, said that the MI325X stands apart from the competition thanks to its boosted performance and memory capabilities.

Billed as the next generation of the MI300X, the 325 offers 30% more floating-point operations per second (FLOPS) compared to its predecessor and boasts increased memory for both bandwidth and capacity.

Compared to Nvidia's H200 GPU, AMD's MI325X offers 1.2 to 1.4 times improved performance powering open source AI workloads for models like [Meta's Llama 3](#), Qwen from Alibaba Cloud, and Mixtral from Mistral AI.

"[The MI325X] is going to, we believe, serve our clients very well as they continue to grow," McCredie said during a press briefing.

The MI325X will be made available in the same form factor as the MI300X — with eight GPUs connected on one pod, the UBD8.

McCredie suggested the interconnected eight MI325Xs will provide "the largest memory and the largest amount of memory bandwidth in a pod for the entire industry."

Compared to the Nvidia equivalent, the DGX H200, the AMD pod offers 30% more memory bandwidth and FLOPs with 1.8 times the memory capacity.

McCredie also confirmed during the press briefing that the MI325X can support up to 1,000 watts of power.

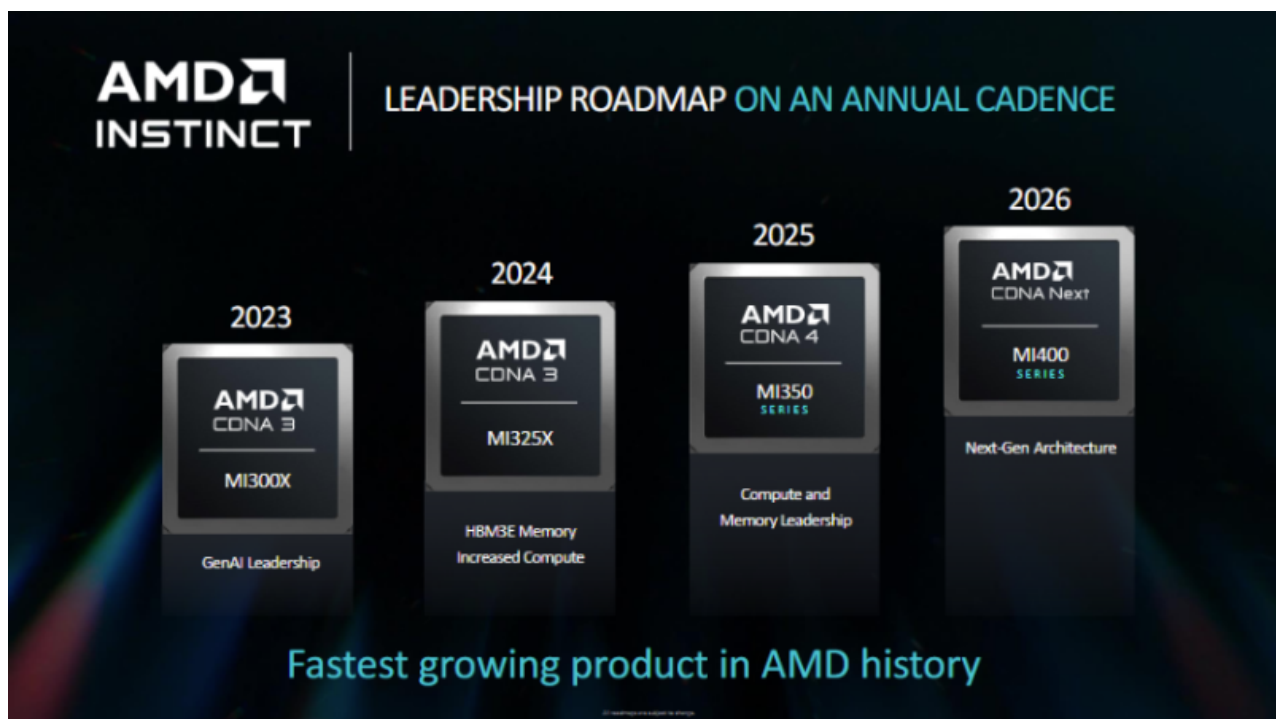
No details were provided on the power consumption capabilities of the MI355X, however, McCredie said it'll be expected to follow industry trends around the time of release.

No word was provided on pricing for the GPUs, either.

Annual cadence: Keeping up with Nvidia's rhythm

Earlier this year at Computex, Nvidia CEO Jensen Huang unveiled the company's plan to launch a powerful new GPU annually, which he described as the "one-year rhythm."

AMD appears to be following suit with what it describes as its "annual cadence" for its Instinct GPUs.



Briefly outlining the company's upcoming hardware roadmap, Dieckmann said that the MI325X will go into volume production in the current quarter and will ship next year. The MI355X will also ship in 2025.

Also teased for 2026 is the MI400X — a next-gen GPU with little information known about it.

Dieckmann suggested the MI400X would be a complete architectural overhaul of its Instinct product.

Nothing concrete was revealed about what the MI400X's architecture would look like, but at AMD's [Computex update in June](#), the company said the architecture would be called 'Next.'

“We're going to be adding many new features and capabilities in [the MI400X],” Dieckmann added. “Generally, we'll talk more about that next year as well.”

RELATED STORIES

[AMD unleashes next-gen AI processors to power enterprise PCs](#)

[AMD launches 5th gen EPYC CPUs to supercharge enterprise AI, cloud workloads](#)

[AMD launches new DPUs to boost AI efficiency and network performance in data centres](#)